

1200V, 25A, $V_{ce(on)} = 2.5V$ Typical

Ultra Fast NPT - IGBT®

The Ultra Fast NPT - IGBT® family of products is the newest generation of planar IGBTs optimized for outstanding ruggedness and the best trade-off between conduction and switching losses.

<u>Features</u>

- · Low Saturation Voltage
- Low Tail Current
- RoHS Compliant

- Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current



All Ratings: T_C = 25°C unless otherwise specified.

300



Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).

MAXIMUM RATINGS

	<u> </u>					
Symbol	Parameter	Ratings	Unit			
V _{ces}	Collector Emitter Voltage	1200	V			
$V_{\rm GE}$	Gate-Emitter Voltage	±30	ĺ			
I _{C1}	Continuous Collector Current @ T _c = 25°C	75				
I _{C2}	Continuous Collector Current @ T _C = 125°C	25	A			
I _{CM}	Pulsed Collector Current ①	100				
SCWT	Short Circuit Withstand Time: V _{CE} = 600V, V _{GE} = 15V, T _C =125°C	10	μs			
P _D	Total Power Dissipation @ T _c = 25°C	521	W			
T _J ,T _{STG}	Operating and Storage Junction Temperature Range	-55 to 150				
			°C			

STATIC ELECTRICAL CHARACTERISTICS

Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.

Symbol	Parameter	Min	Тур	Max	Unit
V _{(BR)CES}	Collector-Emitter Breakdown Voltage $(V_{GE} = 0V, I_{C} = 600\mu\text{A})$	1200			
V _{GE(TH)}	Gate Threshold Voltage $(V_{CE} = V_{GE}, I_{C} = 1.0 \text{mA}, T_{j} = 25 ^{\circ}\text{C})$	3.5	5.0	6.5	Volts
V _{CE(ON)}	Collector-Emitter On Voltage (V _{GE} = 15V, I _C = 25A, T _j = 25°C)		2.5	3.2	
	Collector-Emitter On Voltage (V _{GE} = 15V, I _C = 25A, T _j = 125°C)		3.3		
	Collector-Emitter On Voltage (V _{GE} = 15V, I _C = 50A, T _j = 25°C)		3.5		
I _{CES}	Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 25°C) ②		10	600	μΑ
	Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 125°C) ②		100		
I _{GES}	Gate-Emitter Leakage Current (V _{GE} = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

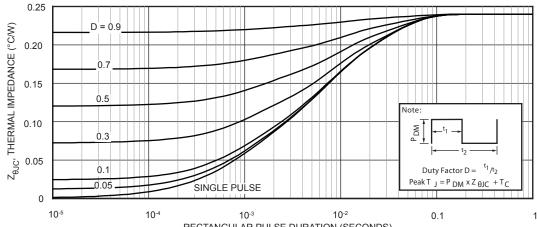
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C _{ies}	Input Capacitance	Capacitance		2784		
C _{oes}	Output Capacitance	$V_{GE} = 0V, V_{CE} = 25V$		271		pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz		75		
V _{GEP}	Gate to Emitter Plateau Voltage	Cata Charria		7.5		V
Q _g 3	Total Gate Charge	Gate Charge		154	203	
Q_{ge}	Gate-Emitter Charge	$V_{GE} = 15V$		20	27	0
Q_{gc}	Gate- Collector Charge	$V_{CE} = 600V$ $I_{C} = 25A$		76	97	nC
t _{d(on)}	Turn-On Delay Time	Inductive Switching (25°C)		16		
t _r	Current Rise Time	V _{cc} = 600V		10		20
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		122		ns
t _f	Current Fall Time	I _c = 25A		20		
E _{on2} ⑤	Turn-On Switching Energy	$R_{G} = 4.3 \Omega^{(4)}$		742	1110	1
E _{off}	Turn-Off Switching Energy	$T_J = +25^{\circ}C$		427	640	μJ
t _{d(on)}	Turn-On Delay Time	Inductive Switching (125°C)		16		
t _r	Current Rise Time	V _{cc} = 600V		10		20
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		136		ns
t _r	Current Fall Time	I _c = 25A		28		
E _{on2} 5	Turn-On Switching Energy	$R_{G} = 4.3 \Omega^{(4)}$		1297	1945	1
E _{off}	Turn-Off Switching Energy	T _J = +125°C		480	720	μJ

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic	Min	Тур	Max	Unit
_	Junction to Case Thermal Resistance (IGBT)			.24	°C/W
R _{eJC}	Junction to Case Thermal Resistance (Diode)			1.18	
$R_{_{\theta JA}}$	Junction to Ambient Thermal Resistance			40	
14/	Package Weight		.22		oz
W_{T}			6.2		g
Torque	Mounting Torque (TO-247 Package), 4-40 or M3 screw			10	in-lbf
				6.2	N·m

- 1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.
- 2 Pulse test: Pulse Width $< 380\mu s$, duty cycle < 2%.
- 3 See Mil-Std-750 Method 3471.
- 4 R_g is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)
- 5 E_{on2} is the clamped inductive turn on energy that includes a commutating diode reverse recovery current in the IGBT turn on energy loss. A combi device is used for the clamping diode.
- 6 E_{off} is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

Microsemi reserves the right to change, without notice, the specifications and information contained herein.



RECTANGULAR PULSE DURATION (SECONDS)
Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

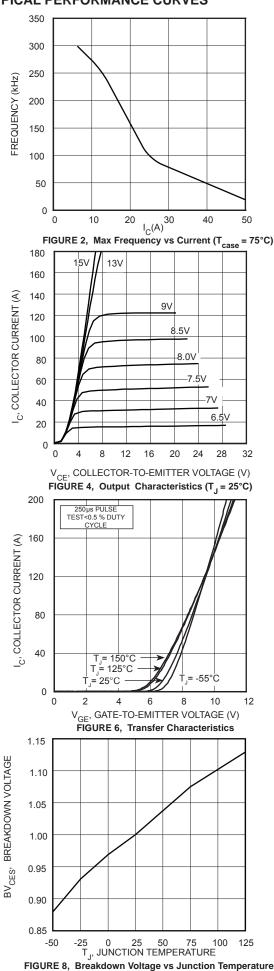
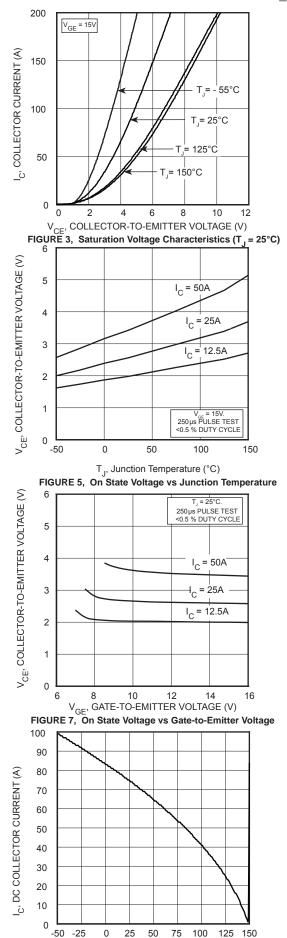
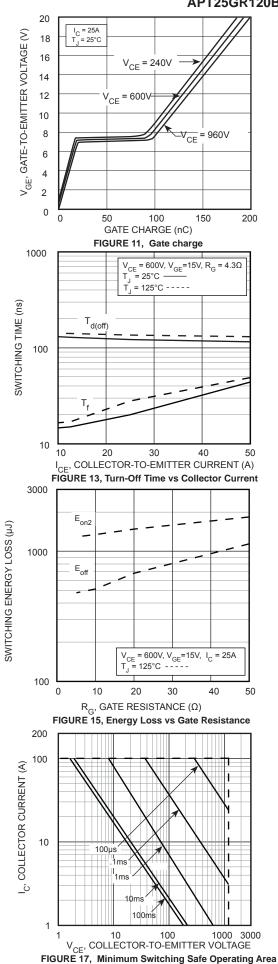


FIGURE 8, Breakdown Voltage vs Junction Temperature



T_C, Case Temperature (°C) FIGURE 9, DC Collector Current vs Case Temperature



ULTRAFAST SOFT RECOVERY RECTIFIER DIODE

All Ratings: $T_C = 25$ °C unless otherwise specified. **MAXIMUM RATINGS**

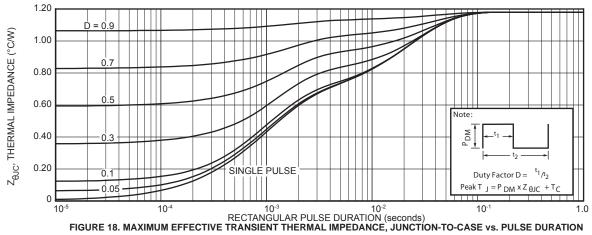
Symbol	Characteristic / Test Conditions	APT25GR120B_SD15	Unit
I _{F(AV)}	Maximum Average Forward Current (T _C = 126°C, Duty Cycle = 0.5)	15	
I _{F(RMS)}	RMS Forward Current (Square wave, 50% duty)	29	Amps
I _{FSM}	Non-Repetitive Forward Surge Current (T _J = 45°C, 8.3 ms)	110	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		Min	Туре	Max	Unit
V _F	Forward Voltage	I _F = 15A		2.8		
		I _F = 30A		3.4		Volts
		I _F = 15A, T _J = 125°C		2.45		

DYNAMIC CHARACTERISTICS

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
t _{rr}	Reverse Recovery Time	$I_F = 1A$, $di_F/dt = -100A/\mu s$, $V_R = 30V$, $T_J = 25$ °C	-	21	-	ns
t _{rr}	Reverse Recovery Time		-	240	-	
Q _{rr}	Reverse Recovery Charge	$I_F = 15A$, $di_F/dt = -200A/\mu s$	-	260	-	nC
I _{RRM}	Maximum Reverse Recovery Current	$V_{R} = 800V, T_{C} = 25^{\circ}C$	-	3	-	Amps
t _{rr}	Reverse Recovery Time	$I_F = 15A$, $di_F/dt = -200A/\mu s$ $V_R = 800V$, $T_C = 125^{\circ}C$	-	290	-	ns
Q_{rr}	Reverse Recovery Charge		-	960	-	nC
I _{RRM}	Maximum Reverse Recovery Current		-	6	-	Amps
t _{rr}	Reverse Recovery Time	$I_F = 15A$, $di_F/dt = -1000A/\mu s$ $V_R = 800V$, $T_C = 125^{\circ}C$	-	130	-	ns
Q _{rr}	Reverse Recovery Charge		-	1340	-	nC
I _{RRM}	Maximum Reverse Recovery Current		-	19	-	Amps



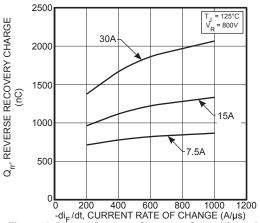
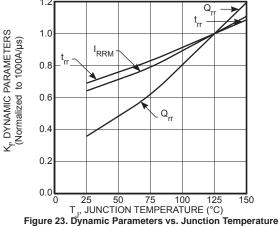
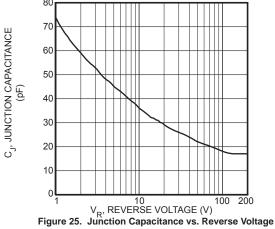


Figure 21. Reverse Recovery Charge vs. Current Rate of Change





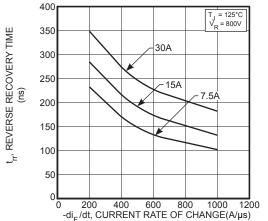


Figure 20. Reverse Recovery Time vs. Current Rate of Change

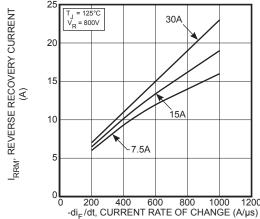


Figure 22. Reverse Recovery Current vs. Current Rate of ChangeTum testic

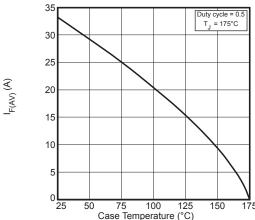


Figure 24. Maximum Average Forward Current vs. CaseTemperature

Figure 26. Diode Test Circuit

- 1 I_E Forward Conduction Current
- 2 di₋/dt Rate of Diode Current Change Through Zero Crossing.
- 3 I_{RRM} Maximum Reverse Recovery Current
- 4 t_{rr} Reverse Recovery Time measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through I_{RRM} and 0.25, I_{RRM} passes through zero.
- $\mathbf{5}$ \mathbf{Q}_{rr} Area Under the Curve Defined by \mathbf{I}_{RRM} and \mathbf{t}_{RR} .

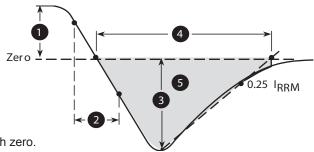
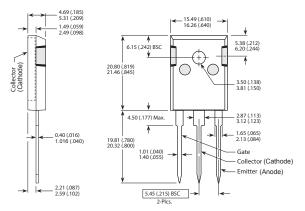


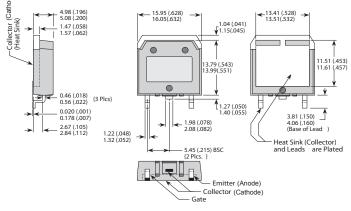
Figure 27. Diode Reverse Recovery Waveform Definition

TO-247 Package Outline



Dimensions in Millimeters (Inches)

D³PAK Package Outline



Dimensions in Millimeters (Inches)

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 IKFW50N65EH5XKSA1
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 XD25H120CX0
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